

UPDATED 07/25/2007

10.7-11.7 GHz 12-Watt Internally Matched Power FET

FEATURES

- 10.7-11.7GHz Bandwidth
- Input/Output Impedance Matched to 50 Ohms
- +40.5 dBm Output Power at 1dB Compression
- 6.0 dB Power Gain at 1dB Compression
- 27% Power Added Efficiency
- -46 dBc IM3 at PO = 28.5 dBm SCL
- 100% Tested for DC, RF, and R_{TH}

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

SYMBOL	PARAMETERS/TEST CONDITIONS ¹	MIN	TYP	MAX	UNITS
P _{1dB}	Output Power at 1dB Compression $f = 10.7-11.7GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200\text{mA}$	39.5	40.5		dBm
G _{1dB}	Gain at 1dB Compression $f = 10.7-11.7GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200\text{mA}$	5.0	6.0		dB
∆G	Gain Flatness $f = 10.7-11.7GHz$ $V_{DS} = 10 \text{ V}, I_{DSQ} \approx 3200\text{mA}$			±0.6	dB
PAE	Power Added Efficiency at 1dB Compression V_{DS} = 10 V, $I_{DSQ} \approx 3200$ mA f = 10.7-11.7GHz		27		%
Id _{1dB}	Drain Current at 1dB Compression f = 10.7-11.7GHz		3300	3700	mA
IM3	Output 3rd Order Intermodulation Distortion Δf =10MHz 2-Tone Test. Pout=28.5 dBm S.C.L Vds = 10 V, $I_{DSQ} \approx 65\%$ I_{DSS} f = 11.7GHz	-43	-46		dBc
I _{DSS}	Saturated Drain Current $V_{DS} = 3 V$, $V_{GS} = 0 V$		5800	7200	mA
V_P	Pinch-off Voltage $V_{DS} = 3 \text{ V}, I_{DS} = 58 \text{ mA}$		-2.5	-4.0	V
R _{TH}	Thermal Resistance ³		2.3	2.6	°C/W

Note: 1. Tested with 50 Ohm gate resistor.

ABSOLUTE MAXIMUM RATING^{1,2}

SYMBOLS	PARAMETERS	ABSOLUTE ¹	CONTINUOUS ²	
Vds Drain-Source Voltage		15	10V	
Vgs	Gate-Source Voltage	-5	-4V	
lgsf	Forward Gate Current	130mA	43mA	
lgsr	Reserve Gate Current	-21mA	-7mA	
Pin	Input Power	40.0dBm	@ 3dB Compression	
Tch	Channel Temperature	175 °C	175 °C	
Tstg	Storage Temperature	-65 to +175 °C	-65 to +175 °C	
Pt	Total Power Dissipation	57W	57W	

Note: 1. Exceeding any of the above ratings may result in permanent damage.

^{2.} S.C.L. = Single Carrier Level.

^{3.} Overall Rth depends on case mounting.

^{2.} Exceeding any of the above ratings may reduce MTTF below design goals.

EIC1011-12

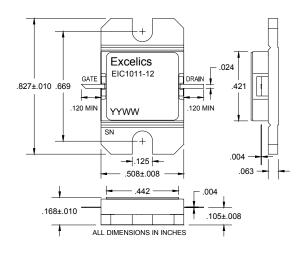
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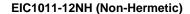
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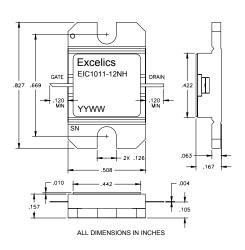
PACKAGES OUTLINE

Dimensions in inches, Tolerance + .005 unless otherwise specified

EIC1011-12 (Hermetic)









Caution! ESD sensitive device.



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ORDERING INFORMATION

Part Number	Packages	Grade ¹	f _{Test} (GHz)	P _{1dB} (min)	IM ₃ (min) ²
EIC1011-12	Hermetic	Industrial	10.7-11.7GHz	40.0	-43
EIC1011-12NH	Non-Hermetic	Industrial	10.7-11.7GHz	40.0	-43

Notes:

- 1. Contact factory for military and hi-rel grades.
- 2. Exact test conditions are specified in "Electrical Characteristics" table.

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